

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Bruce Alvin Gurney	09/10/2010
Ernesto E. Marinero	08/27/2010
Simone Pisana	08/25/2010
<b>RECEIVING PARTY DATA</b>	
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<b>State/Country:</b>	NETHERLANDS
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12880071
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<b>Total Attachments: 1</b> source=HSJ920100055US1_AssignmentSigned#page1.tif	

CH \$40.00 12880071

## ASSIGNMENT FOR PATENT APPLICATION


Whereas, I/we the undersigned inventor(s) have invented certain improvements as set forth in the patent application entitled:


### MAGNETIC FIELD SENSOR WITH GRAPHENE SENSE LAYER AND FERROMAGNETIC BIASING LAYER BELOW THE SENSE LAYER

Whereas, **Hitachi Global Storage Technologies Netherlands B.V.**, having a place of business at Locatellikade 1, Parnassustoren, 1076 AZ Amsterdam, The Netherlands (hereinafter referred to as "HITACHI"), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby sell, assign, and transfer to HITACHI, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HITACHI, its successors and assigns; and we hereby agree that HITACHI may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HITACHI.

Signed on the date(s) indicated beside my (our) signature(s).

1) Signature:   
Typed Name: **Bruce Alvin Gurney** Date: 9/10/2010

2) Signature:   
Typed Name: **Ernesto E. Marinero** Date: 08/27/2010

3) Signature:   
Typed Name: **Simone Pisana** Date: 08/25/2010